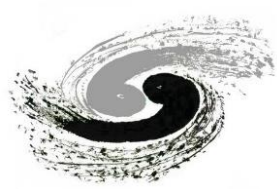


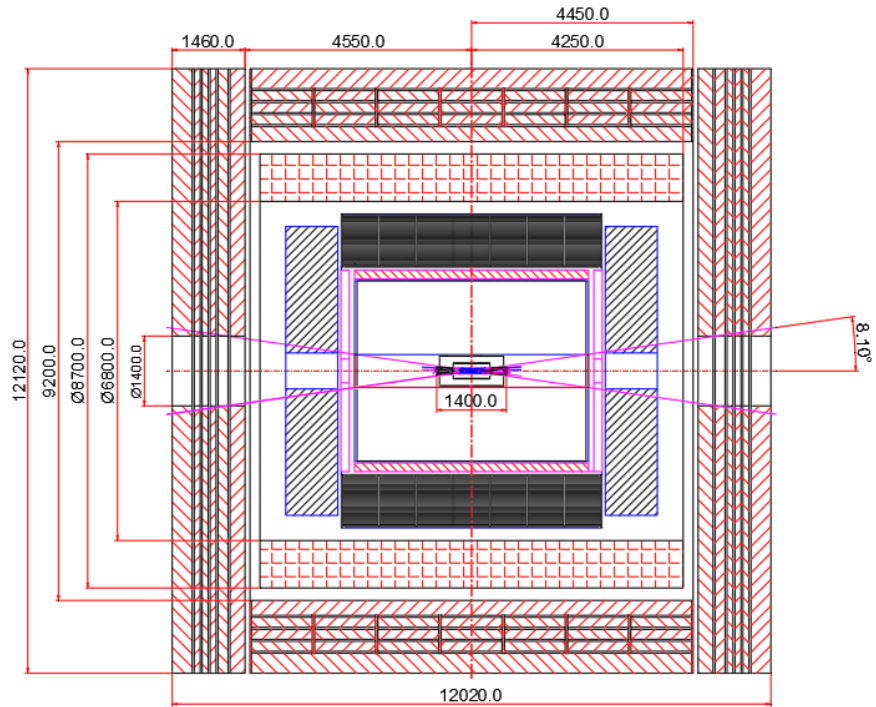
CEPC HCAL Mechanics: studies and discussions

Yong Liu (IHEP),
for the CEPC Calorimeter Group
May 21, 2021

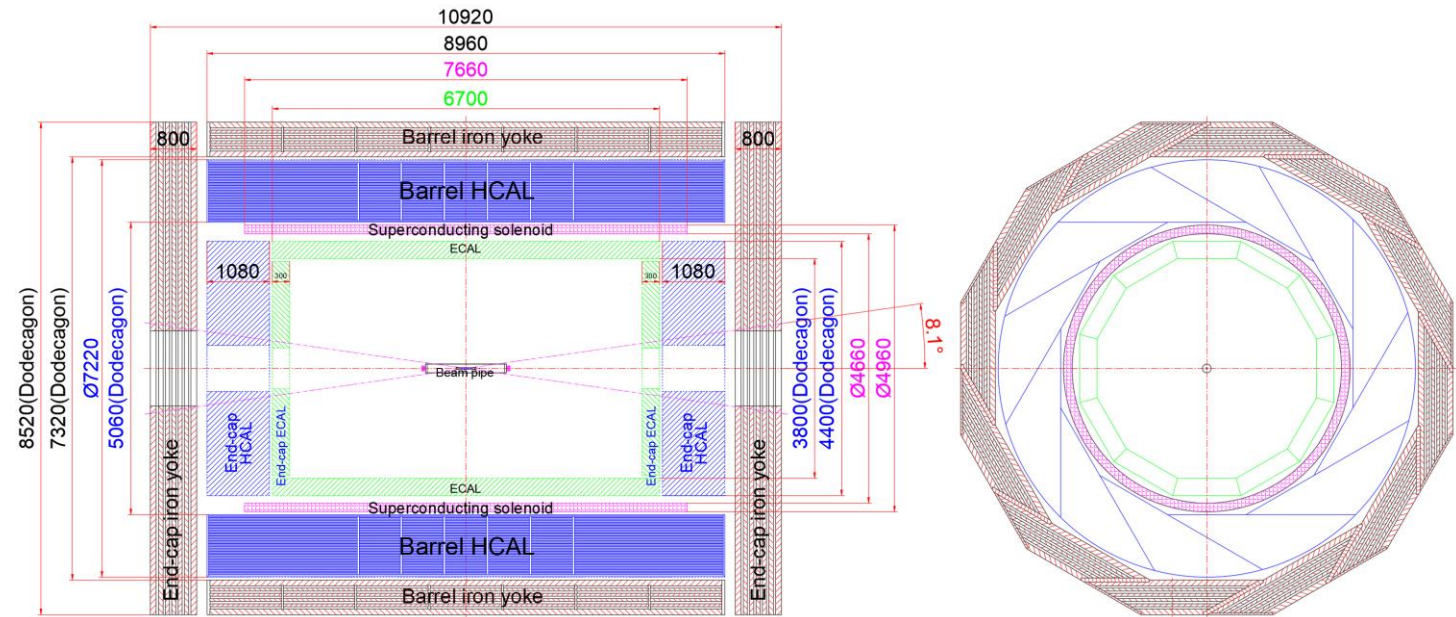


CEPC detector mechanics: reminder

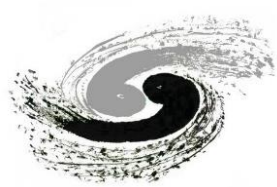
- CEPC detector layout evolving: a few options proposed



A detector layout in the [Mechanics Workshop 2020](#) by Quan Ji (IHEP)



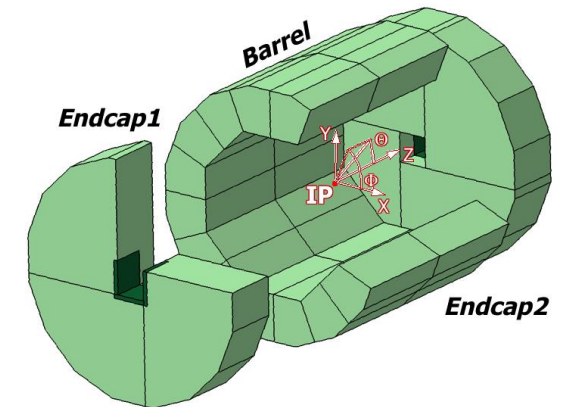
A new detector layout in the [Yangzhou Joint Workshop 2021](#) by Quan Ji (IHEP)



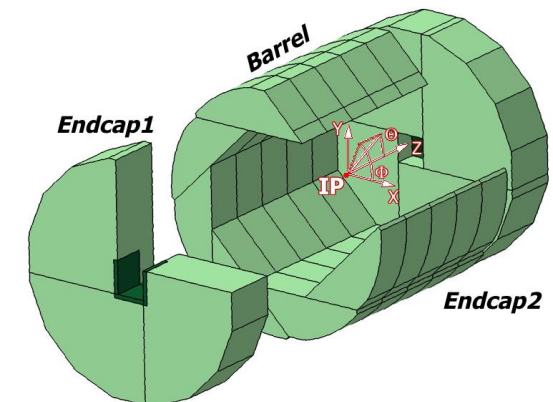
HCAL mechanics: context

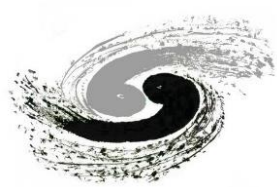
- Mechanics for CEPC PFA-oriented Hadron Calorimeter
 - Two major designs at hand
 - Originated from ILD: [ILD LOI \(2010\)](#), [ILC TDR Volume 4 \(2013\)](#)
- Discussions within the CEPC calorimeter group meetings
 - Comparisons between the two designs: pros and cons
 - Focus on the barrel part
 - + mechanical engineer: Quan Ji (IHEP)
- Contents in this talk
 - A brief summary of the discussions
 - Highlights of existing simulation studies within CALICE Collab.

Layout 1: symmetric barrel



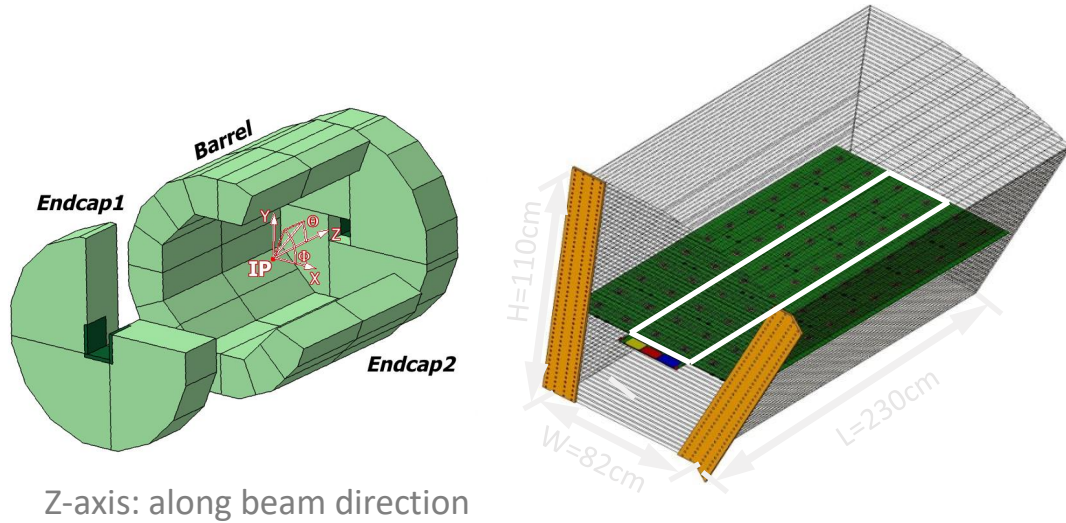
Layout 2: asymmetric barrel





HCAL layouts: comparison

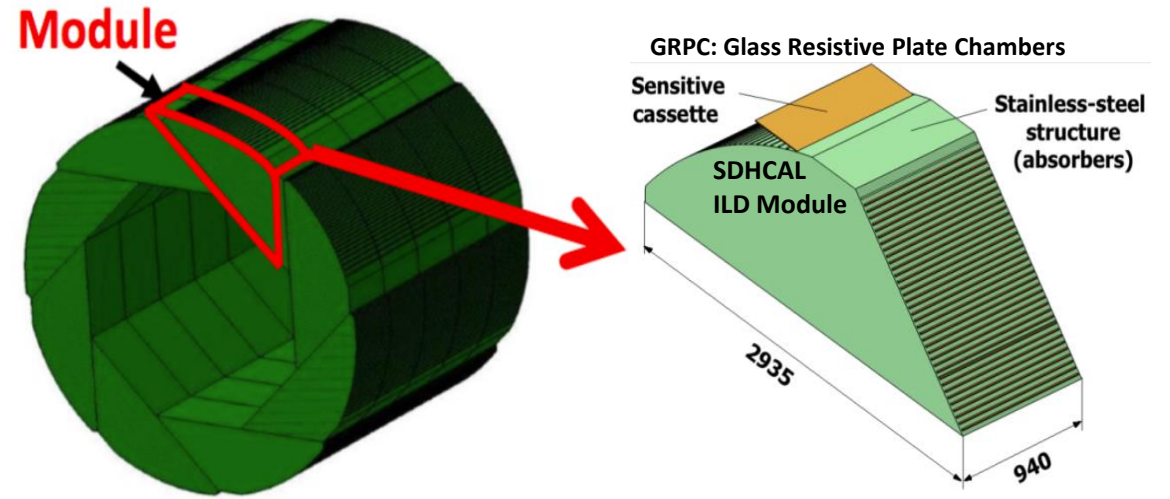
HCAL Layout 1



Symmetric Layout

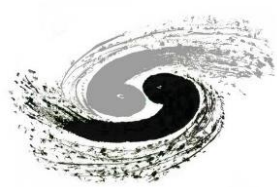
- + Similar module sizes: friendly for QA/QC
- Projectile cracks from IP (z, φ): possible impacts to performance
- Difficulty for installation and maintenance from each side (along z)
 - Extra challenges for some designs of longer barrel HCAL (8-9m long); (Reminder: 4.7m for HCAL in ILD and CEPC CDR)

HCAL Layout 2



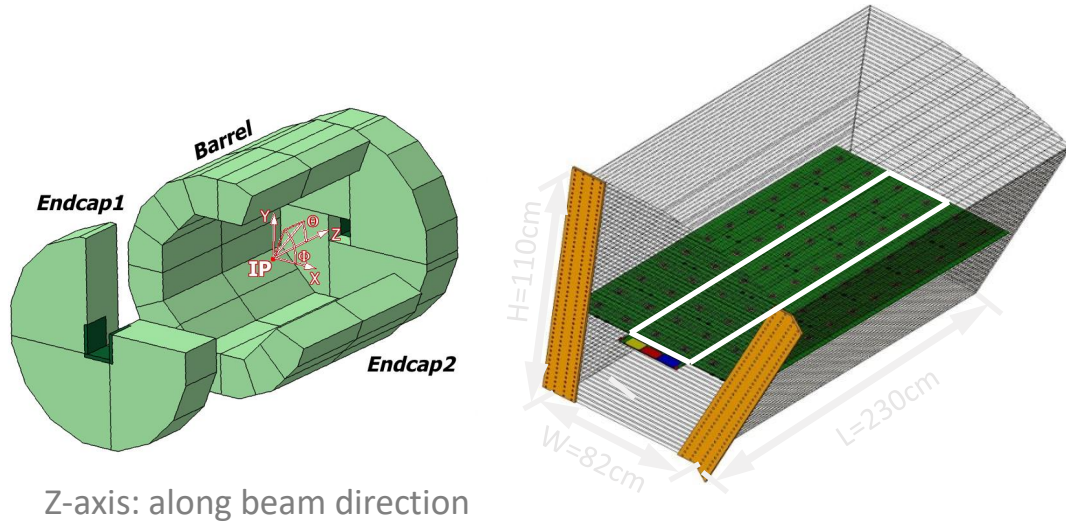
Asymmetric/spiral Layout

- + Avoid projectile cracks from IP along (z, φ)
- + Handy for installation and maintenance (along outer radius)
- Very different module sizes: challenges for QA/QC



HCAL layouts: comparison

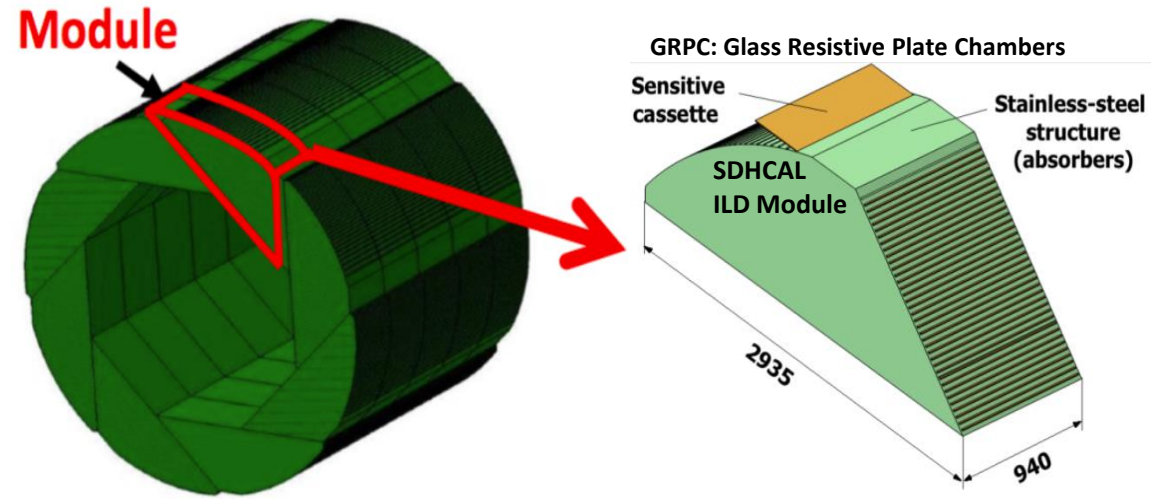
HCAL Layout 1



Symmetric Layout

- + Similar module sizes: friendly for QA/QC
- Projectile cracks from IP (z, φ): possible impacts to performance
- Difficulty for installation and maintenance from each side (along z)
 - Extra challenge for longer barrel HCAL designs (8-9m long); **ILD 4.7m**

HCAL Layout 2



Asymmetric/spiral Layout

- + Avoid projectile cracks from IP along (z, φ)
- + Handy for installation and maintenance (along outer radius)
- Very different module sizes: challenges for QA/QC

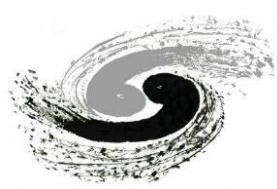
Technical challenges for both layouts:

- (1) production/assembly of long modules: 2~4m in Layout 1; ~3m in Layout 2
- (2) active cooling system and its integration with mechanics



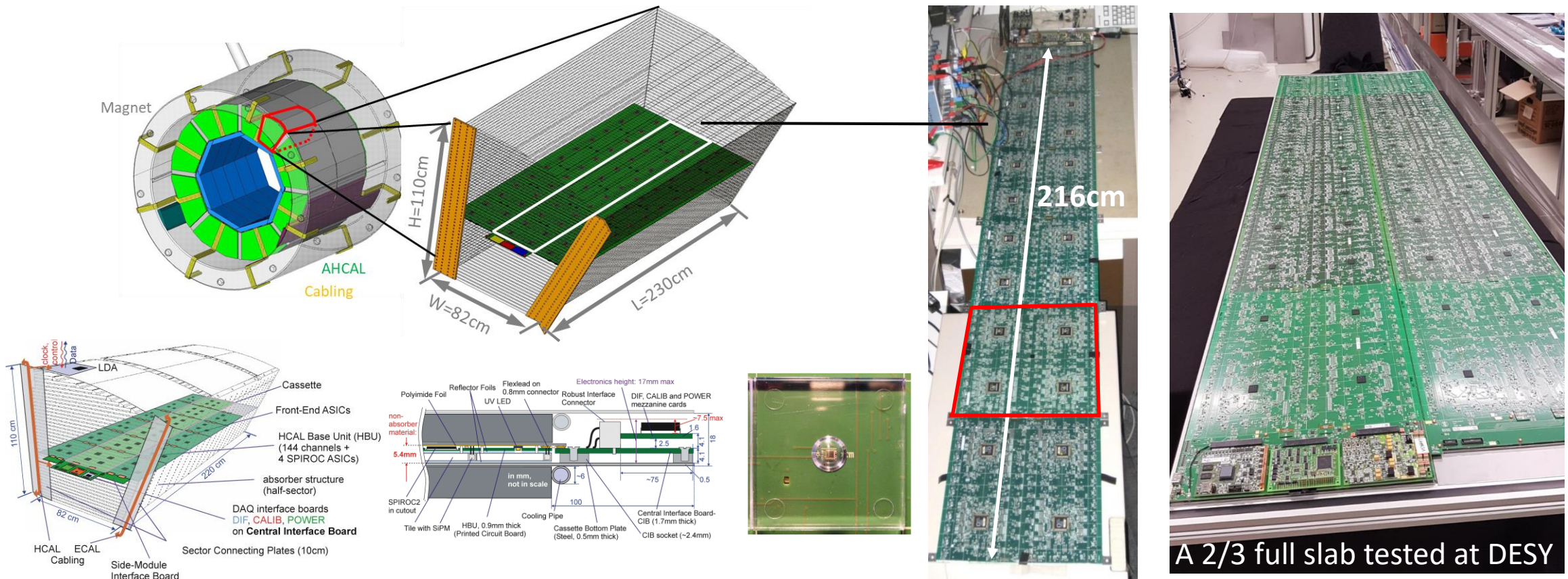
Ongoing R&D efforts to address the challenges (next pages)

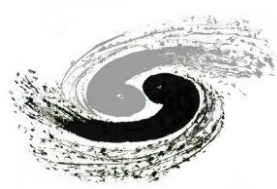
- (1) ~2m long AHCAL slabs (DESY); ~1x2m RPC+PCB (Lyon)
- (2) Simulation studies of an active cooling system (SJTU)



HCAL modules for the final detector

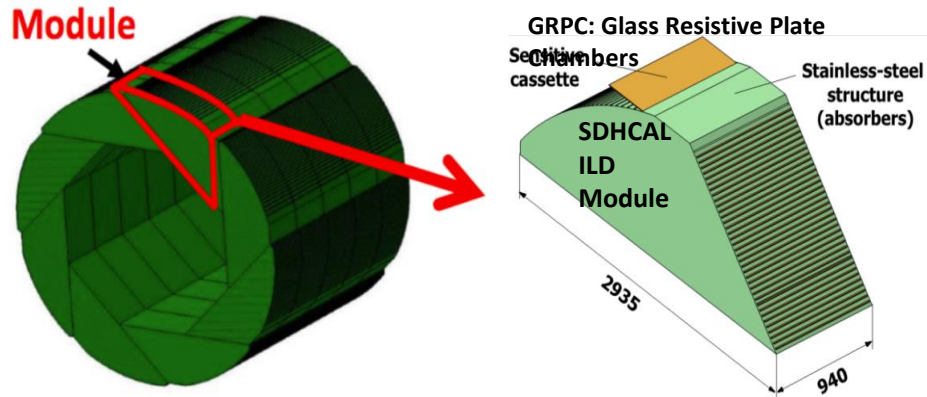
- Ongoing R&D efforts within CALICE to realise large-scale modules
 - Analog HCAL option: “SiPM-on-Tile” technology with steel plates
 - Efforts to test full-sized layers at DESY: aim for 1.1x2.2m² full slabs at ILD



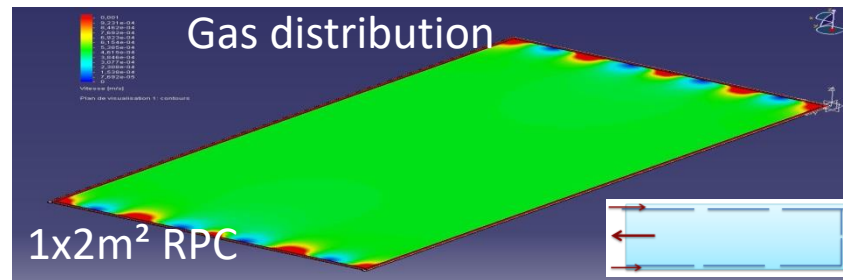


HCAL modules for the final detector

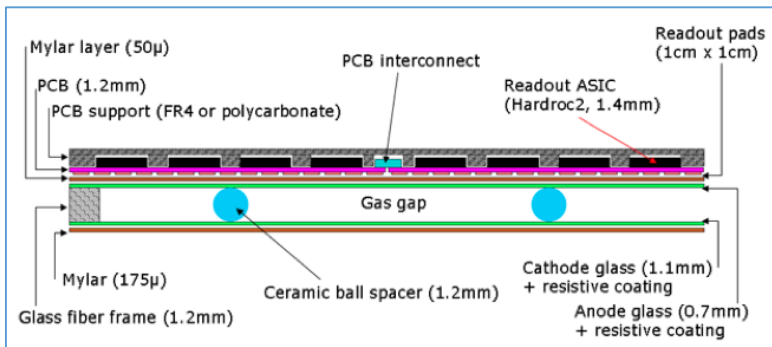
- Ongoing R&D efforts within CALICE to realise large-scale modules
 - Semi-digital HCAL option: large-scale RPC technology with steel plates
 - Efforts to build full-sized layers at Lyon: aim for full 1x3m² slabs



Assembled 1x2m² large RPC, 1x0.33m² PCBs



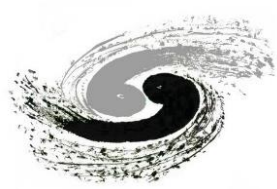
Large-scale steel absorber



Readout board for a large RPC



1x0.33m² PCB



HCAL active cooling

- Active cooling studies for SDHCAL at SJTU and Lyon
- We plan to further investigate for AHCAL: different ASICs (SPIROC2E) and lower granularity

Cooling system : cooling plates

- Cooling plates: water pipes imbedded in metal plates
- Cooling ability: $\sim \text{kW}/\text{m}^2$
- Using water
- Price
- Compactness
- Maintenance
- Flexible framework

ANSYS Simulation of RPC+PCB With copper plate & water tubes

Temperature test of RPC+PCB

Synergies with the CEPC MOST-2 AHCAL prototype construction (40 layers, 72cmx72cm per layer)

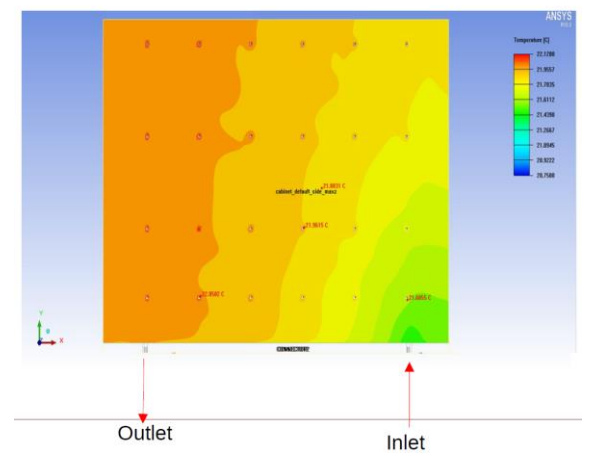
[SDHCAL Electronics, Gas Flow and Cooling at CALICE Collaboration Meeting Mar. 2021](#)
Simulation

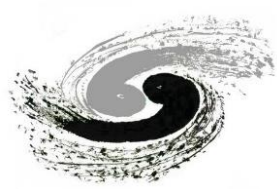
Test of the cooling plates

Test of the cooling plates

Simulation

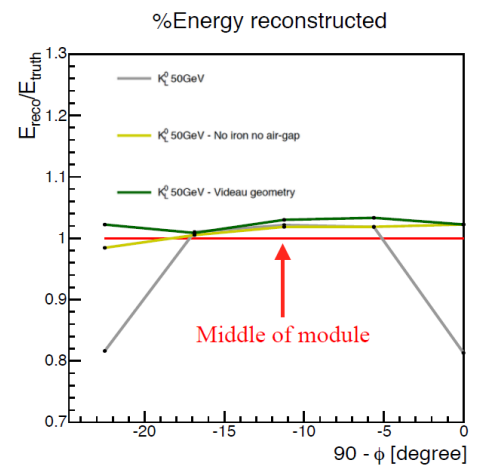
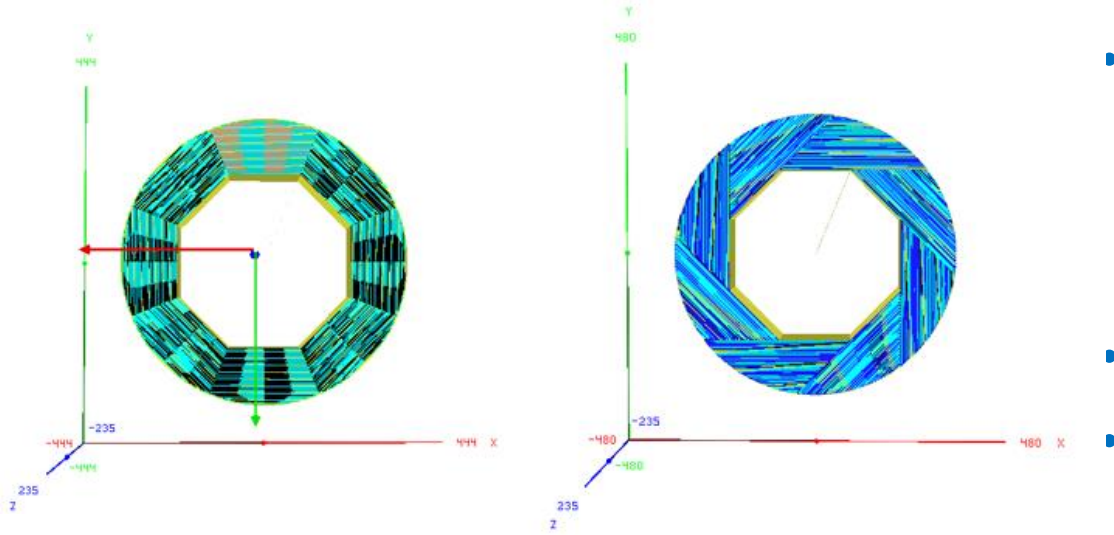
Temperature measurements



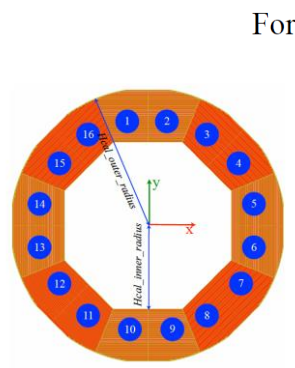
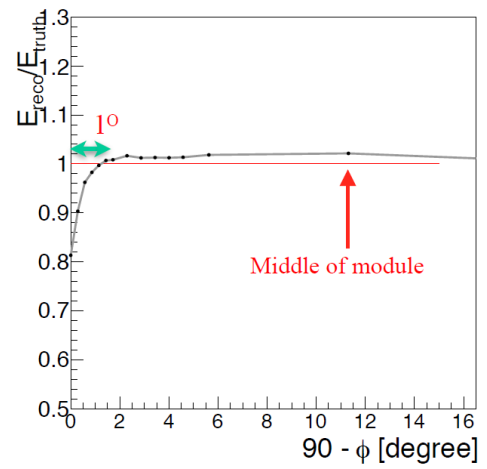


HCAL mechanics: simulation studies within CALICE

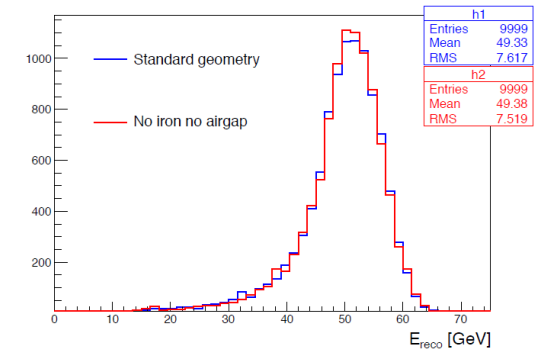
- Comparison of HCAL structures
 - Realistic symmetric structure with gaps
 - Ideal symmetric structure w/o iron and air gaps in ϕ
 - Asymmetric structure
- Loss of energy response and resolution due to cracks
- But this effect is negligible when integrating over all ϕ angles
 - Can be further mitigated by corrections



**Finer
phi steps**
→



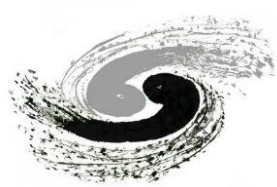
For single particle



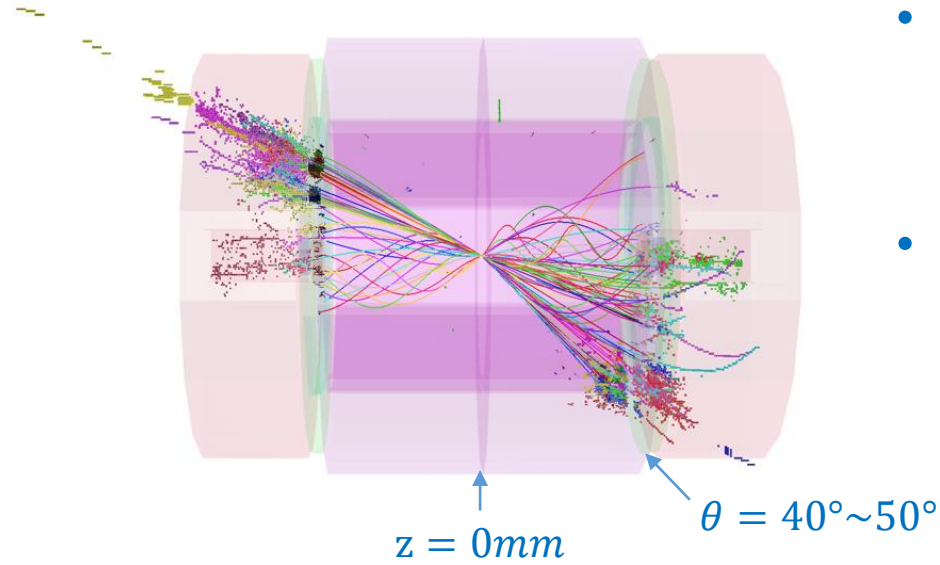
Fit Gaus90
 Mean: 50.6938
 Sigma: 5.07267
 Res(Gaus90) = 10%

Mean: 50.7438
 Sigma: 5.15704
 Res(Gaus90) = 10.2 %

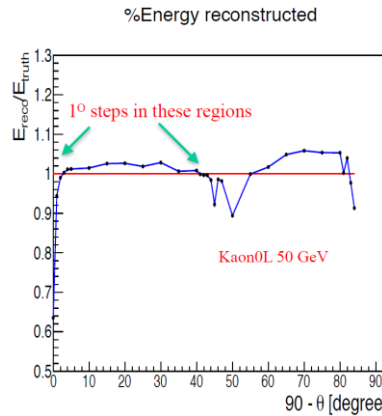
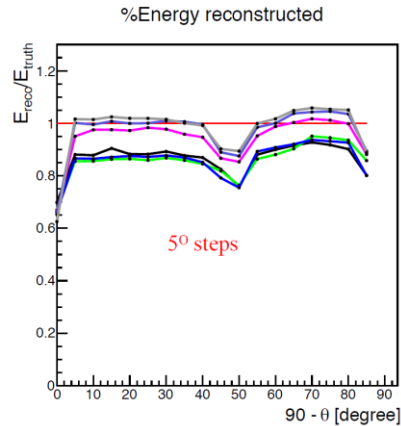
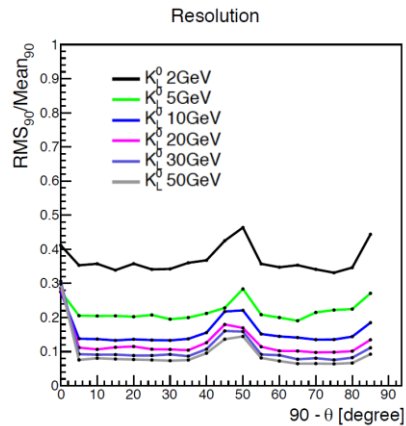
H.L. Tran, AHCAL optimisation using Pandora, LCWS2015



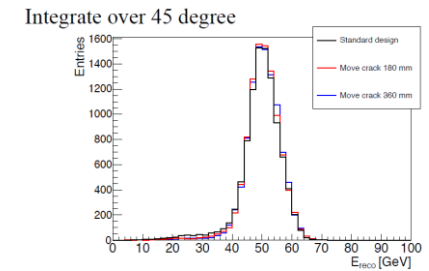
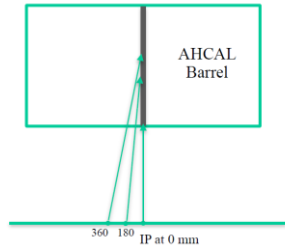
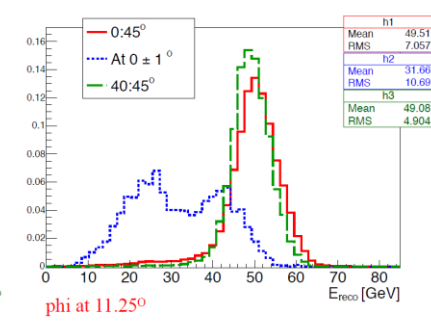
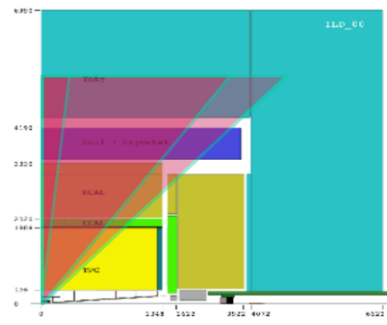
HCAL mechanics: simulation studies within CALICE



- Loss of energy response and resolution
 - At central iron plate ($z = 0$)
 - In transition region between barrel and endcap
- Can be mitigated by
 - Theta-dependent correction
 - Asymmetric barrel around the central plane ($z = 0$): e.g. staircase like



Effect of supporting structure (r,theta) plane

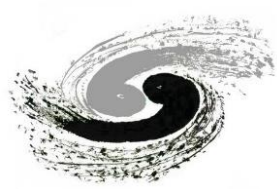


> Middle stave iron support seems to have stronger effect on energy reconstruction.

Possible improvements:

- Cluster's energy correction as a function of theta
- Or: Asymmetric design: middle stave iron support is not anymore "middle"

H.L. Tran, AHCAL optimisation using Pandora, LCWS2015

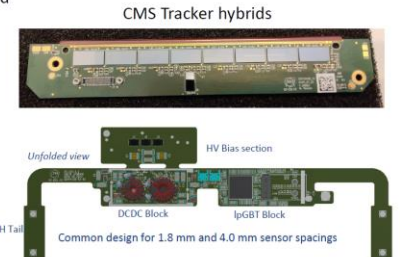
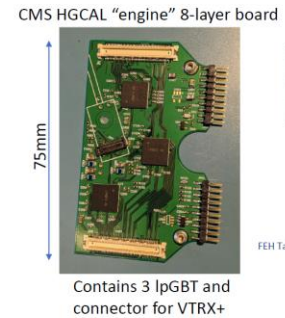
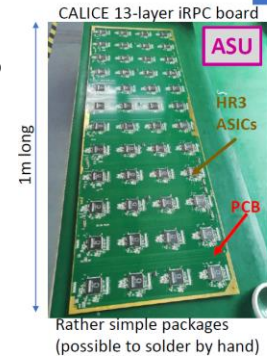


Summary

- Discussions on the HCAL mechanics
 - Symmetric vs. asymmetric layouts
- Ongoing R&D efforts to realise large modules
 - Within the CALICE collaboration
 - To address technical challenges
 - Essential inputs for the down-select process
- Active cooling: further studies for CEPC HCAL
 - Expertise from the SDHCAL team
 - Synergies with the CEPC MOST-2 AHCAL prototype development



"I know companies that make large PCBs
I know companies that make high-density PCBs
(sometimes they are the same company).
But **no company makes high-density large PCBs**"



Dave Barney, ECFA Detector R&D Roadmap Symposium of TF6 Calorimetry, [Lessons learned: calorimeter upgrade R&D for HL-LHC & by CALICE](#)